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ROH-039

PCT SECTION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In the U.S. Nationalization
Application of PCT/JP99/06524

NAKAMURA et al.

Application No. To Be Assigned

Filed: May 25, 2001

For: METHOD OF FORMING SOLID OF A FERROELECTRIC OR HIGH
DIELECTRIC MATERIAL AND METHOD OF MANUFACTURING
SEMICONDUCTOR DEVICE EMPLOYING THE SAME (AS AMENDED)

PRELIMINARY AMENDMENT

Commissioner of Patents
Washington, DC 20231

Sir:

Prior to the initial examination, please amend the above-identified application as follows:

IN THE TITLE:

Please change title of the invention as follows:

--METHOD OF FORMING SOLID OF A FERROELECTRIC OR HIGH DIELECTRIC
MATERIAL AND METHOD OF MANUFACTURING SEMICONDUCTOR DEVICE
EMPLOYING THE SAME--

IN THE SPECIFICATION:

Please replace the specification under 37CFR § 1.121(b)(3). The substitute specification in clean form under 37CFR § 1.125(c), which includes the title of the invention as amended, is attached hereto as APPENDIX I.

The marked up version of the substitute specification under 37CFR § 1.125(b)(2) is attached to hereto as APPENDIX II.

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